

Title (en)
THERMOFORMABLE POLYAMIDES

Title (de)
THERMOFORMBARE POLYAMIDE

Title (fr)
POLYAMIDES THERMOFORMABLES

Publication
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Application
EP 00967783 A 20000926

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Abstract (en)
[origin: US6833429B1] A reinforced polyamide molding composition is disclosed. Characterized in that its viscosity at a shear velocity of 10 s⁻¹ is greater than 1000 Pas and a shear velocity of 1000 s⁻¹ is less than 300 Pas, at processing temperatures of 40 to 80° C. above its melting point, the composition is particularly suitable for thermoforming applications.

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C08L 77/02; **C08L 77/00**; **C08L 77/06**

IPC 8 full level
C08G 69/48 (2006.01); **C08K 3/00** (2006.01); **C08K 5/00** (2006.01); **C08J 5/00** (2006.01); **C08K 7/14** (2006.01); **C08L 77/00** (2006.01)

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C-Set (source: EP US)
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